

## **THERMAL COMPOUNDS, ADHESIVES AND INTERFACE MATERIALS**

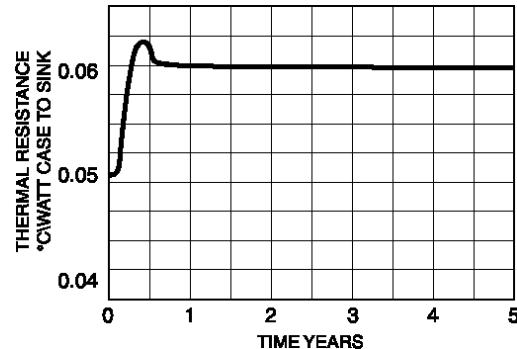
### **120 SERIES**



The **120 Series** Silicone Oil-Based Thermal Joint Compound fills the minute air gap between mating surfaces with a grease-like material containing zinc oxide in a silicone oil carrier. It possesses an excellent thermal resistance of only  $0.05^{\circ}\text{C}/\text{W}$  for a 0.001 in. film with an area of one square inch. There is no measurable increase in case temperature of a mounted semiconductor on a heat sink after the 6-month stabilization period (Time versus Thermal Resistivity graph below).

TYPICAL VALUES FOR THERMAL RESISTANCE, CASE TO SINK ( $\theta_{CS}$ ) WHEN THERMAL JOINT COMPOUNDS ARE USED		
Case Style Characteristics	Mounting Torque in inch • pounds (N•M)	Typical Thermal Resistance ( $^{\circ}\text{C}/\text{W}$ )
TO-3	8 (0.9)	0.09
TO-66	9 (0.9)	0.14
TO-220	8 (0.9) 0.19 (4.8) stud x 0.44 (11.2) hex	0.50 0.16
0.25 (6.4) stud x 0.69 (17.5) hex 0.38 (9.7) stud x 1.06 (26.9) hex	30 (3.39) 75 (8.47)	0.10 0.07
0.50 (12.7) stud x 1.06 (26.9) hex 0.75 (19.1) stud x 1.25 (31.8) hex	125 (14.12) 600 (67.79)	0.07 0.052

120 SERIES - THERMAL JOINT COMPOUND	
Characteristic	Description
Volume Resistivity	$5 \times 10^6$ 14 ohm/cm
Dielectric Strength	225 volts/mil
Specific Gravity	2.1 min.
Thermal Conductivity @ WC	$0.735 \text{ W}/(\text{m})(\text{K})$ $5.1 (\text{Btu}) (\text{in.})(\text{hr})(\text{ft}^2)(^{\circ}\text{F})$
Thermal Resistivity (P)	$56 (^{\circ}\text{C})(\text{in.})/\text{watt}$
Bleed, % after 24 hrs @ $200^{\circ}\text{C}$	0.5
Evaporation, % after 24 hrs @ $200^{\circ}\text{C}$	0.5
Color	opaque white
Shelf life	5 years
Operating Temperature Range ( $^{\circ}\text{C}$ )	-40/+200



120 SERIES - ORDER GUIDE	
Series - P/N	Container Size
120-SA ▲	4 gram plastic pak
120-2 ▲	2 oz (0.06 kg) jar
120-5 ▲	5 oz (0.14 kg) tube
120-8 ▲	8 oz (0.23 kg) jar
120-80 ▲	5 lb (2.27 kg) can
120-320	20 lb (9.08 kg) can

### **126 SERIES**



The **126 Series** is a nontoxic, synthetic, ester-based (nonsilicone) Thermal Joint Compound with metal oxide fillers designed to enhance thermal performance characteristics of plastic and metal package devices exceeding that of silicone-based compounds. Solved are problems associated with contamination of wave solder baths and migration of silicone-based products.

Shelf life: 5 years.

126 SERIES THERMAL JOINT COMPOUND	
Characteristics	Description
Appearance	Smooth, white homogeneous paste
Solids Content, wt %	65% min
Thermal Conductivity at $36^{\circ}\text{C} = 4.8 (\text{Btu})(\text{in.})(\text{hr})(\text{ft}^2)(^{\circ}\text{F})$	$19.0 \times 10^6$ 4 cal/sec cm $^{\circ}\text{C}$ , min
Interface Thermal Resistance	$0.043^{\circ}\text{C}/\text{W}$ TO-3 at 0.00008 thick film
Bleed, 24 hrs at $200^{\circ}\text{C}$ , wt%	0.09% max
Evaporation, 24 hrs at $200^{\circ}\text{C}$ , wt%	0.6 max
Volume Resistivity	$2.3 \times 10^6$ 12 ohms/cm
Dielectric Strength	200 volts/mil
Specific Gravity @ $60^{\circ}\text{F}$	2.93 (gm/cc)
Penetration	280 to 320
Operating Range	-40 $^{\circ}\text{C}$ to 200 $^{\circ}\text{C}$

126 SERIES - ORDER GUIDE	
Series - P/N	Container Size
126-2 ▲	2 oz (0.6 kg) jar
126-4	4 oz (0.11 kg) tube
126-4S	4 oz (0.11 kg) syringe
126-5LB	5 lb (2.27 kg) can

## THERMAL COMPOUNDS, ADHESIVES AND INTERFACE MATERIALS

### DeltaBond™ 152



**DeltaBond™ 152** adhesive is ideal for general cementing; thermally bonding semiconductors and components to chassis or heat sinks, while electrically isolating one from the other; fabricating heat sinks or thermal links; and for all permanent bonding of assemblies which require high thermally conductive interfaces. It produces a rigid, high strength bond to most materials when cured. **DeltaBond™ 152** is available in bi-packs, kits, and quarts. Order one bottle of hardener A-4 or B-4 per one quart of **DeltaBond™ 152** separately. Shelf life: 152KA 1 year, all others 2 years.

DELTABOND™152		
Characteristics	Hardener Type	
Typical Properties Fully Cured	A4	B-4
Thermal conductivity - W/(m) (°K)	0.836	0.908
(Btu) (in.)/(hr) (ft²) (°F)	5.8	6.3
Thermal resistivity - (°C) (in.)watt	47	42
Bond shear strength 77°F 1 in. overlap - psi 125°F etched aluminum to etched aluminum 212°F	2,900 2,200 400	2,300 2,000 800
Heat distortion point - °F	130	225
Minimum dielectric strength, v/mil, 0.125 in. sample	400	400
Max operation temp - °C	Continuous Intermittent	65 100 190
		150

DELTABOND™152		
Mixing Proportions and Working Properties		
Characteristics	A-4	B4
Parts of hardener per 100 parts of resin by weight	7.5	3.5
*Working Time - at 77°F	45 min	30 min
†Initial cure time 77°F 150°F 250°F	8 hrs 45 min 20 min	6 hrs 30 min 15 minn
‡Post-cure time at a temp in °F	4 hrs @200°F	4 hrs @ 200°F
‡Alternate room temp. aging time at 77°F	4 days	4 days
Working consistency (77°F)	viscous liquid	paste
Working viscosity (77°F) cps	25,000	—

Model Number	DELTABOND™152		
	Ordering Guide - Resin and Hardener		Hardener
	Part No.	Container	
DeltaBond™ 152	152-1A 152-1B 152-KA 152-Q	Bi-Pack (1 oz) Bi-Pack (1 oz) Kit (7 oz Resin, 0.5 oz Hardener) 1 quart (4 lbs)	Included in PIN 152-1 A ("A-4") Type Included in PIN 152-1 B ("B-4") Type Included in P/N 152-KA A-4 (0.316 lb), B-4 (0.14 lb), (order 1 only)

All hardener part numbers  
A-4, B-4

#### NOTES:

- \* Since the hardener/resin reaction is exothermic, it is important that batch size be matched to hardener speed. Working times given are for approximate batch sizes: A—200 gms, B—200 gms. Larger batch sizes will greatly reduce working time.
- \*\* For optimum electrical properties, dry parts for 15 minutes at 150°F (65°C) or 30 minutes at 75°F (24°C) to slowly evaporate the thinner and then final cure for 4 hours at 275°F (135°C).
- † After initial cure, material may be handled, removed from fixture, etc., but has not yet achieved full properties and should be room temperature aged or post-cured as shown to achieve full physical and electrical properties.
- ‡ After initial cure, material may be brought to full physical and electrical properties during post-cure or may be room temperature aged for charted length of time to achieve same full properties.

The information contained herein is based on data believed to be reliable but we do not assume responsibility for accuracy. All such information is used at the customer's own risk, conditions of use being beyond our control.

## THERMAL INTERFACE MATERIAL DATA FOR T-SERIES AND S-SERIES

**T-Series Thermal Tapes** come double-sided, and can be attached at the factory. Clips or mechanical fasteners are not required when thermal tapes are used. Not to be used for electrical isolation.

Material	Thermal Resistivity Degc in. Watt	Thickness	Description	Manufacturer Reference
T-1	79	0.006	Thermal Tape	Chomerics T-405
T-2	55	0.0045	Thermal Tape	Adhesives Research Arclad 8223
T-3	28	0.009	Thermal Tape	Chomerics T-412
T-4	157	0.007	Thermal Tape	Chomerics T-410

**S-Series Thermal Interface Material** come double-sided, and are applied at the factory only. They fill gaps due to surface roughness and flatness either under pressure or at temperature. These products also require mechanical fasteners. Not to be used for electrical isolation.

Material	Thermal Resistivity Degc in. Watt	Thickness	Description	Manufacturer Reference
S-3	25	0.005	Thermal Interface	Bergquist Q-pad 3
S-4	11	0.005	Thermal Interface	Bergquist softface
S-5	15	0.0055	Thermal Interface	Chomerics T-710
S-6	19	0.0052	Phase-Change Pad	Chomerics T-443
S-7	6	0.003	Tape a/Alum. Sub.	Power Devices Al-S (Thermstrate)
S-8	25	0.0065	Phase-Change Pad	Bergquist 2004

## THERMAL COMPOUNDS, ADHESIVES AND INTERFACE MATERIALS

### DeltaCast™ 153



**DeltaCast™ 153** is a pourable casting resin having thermal expansion characteristics similar to aluminum and copper allowing assemblies to operate over a very wide temperature range. Ideal for encapsulating components and assemblies, this series' major advantages and uses include potted systems (virtually indestructible), protecting components and systems from moisture and contaminants, securing proprietary circuitry, mechanical support of devices, removal of heat from hot components and the assembly equalizing temperatures, and high voltage isolation. DeltaCast™ 153 is available in quarts and gallons. Order one bottle of hardener A4 or B-4 per one quart of DeltaCast™ 153 separately. Shelf life: 2 years.

DELTACAST™153		
Characteristics	Hardener Type	
Typical Properties Fully Cured	A4	B-4
Thermal conductivity - W/(m) (°K)	0.836	0.908
(Btu) (in.)/(hr) (ft²) (°F)	5.8	6.3
Thermal resistivity - (°C) (in.)watt	47	42
Bond shear strength 77°F 1 in. overlap - psi etched aluminum to etched aluminum 212°F	2,500 — —	1,900 — —
Heat distortion point - °F	130	225
Minimum dielectric strength, v/mil, 0.125 in. sample	400	400
Max operation temp - °C	Continuous Intermittent	65 100 150 190

DELTACAST™153		
Characteristics	A-4	B4
Parts of hardener per 100 parts of resin by weight	7.5	3.5
*Working Time - at 77°F	45 min	30 min
† Initial cure time 77°F 150°F 250°F	8 hrs 45 min 20 min	6 hrs 30 min 15 minn
‡Post-cure time at a temp in °F	4 hrs @200°F	4 hrs @ 200°F
‡Alternate room temp. aging time at 77°F	4 days	4 days
Working consistency (77°F)	heavy liquid	viscous liquid
Working viscosity (77°F) cps	10,000	30,000

DELTACAST™153			
Model Number	Ordering Guide - Resin and Hardener		
	Resin		Hardener
	Part No.	Container	Part Number
DeltaCast™ 153	153-Q	1 quart (4 lbs)	A-4 (0.316 lb), B-4 (0.14 lb), (order 1 only)

All hardener part numbers  
A-4, B-4

### DeltaBond™ 154



**DeltaBond™ 154** is a medium viscosity, aluminum-filled resin with the best thermal conductivity of this series. It is, however, neither a good electrical insulator nor conductor. Its principal application is that of a good thermal mechanical adhesive for applications such as bonding fins to base plates or structural mounting blocks or brackets to heat sinks. Shelf life: 2 years.

DETABOND™154		
Characteristics	Hardener Type	
Typical Properties Fully Cured	A4	B-4
Thermal conductivity - W/(m) (°K)	1.053	1.154
(Btu) (in.)/(hr) (ft²) (°F)	7.3	8.0
Thermal resistivity - (°C) (in.)watt	37	34
Bond shear strength 77°F 1 in. overlap - psi etched aluminum to etched aluminum 212°F	3,000 2,300 500	2,400 2,100 800
Heat distortion point - °F	130	225
Minimum dielectric strength, v/mil, 0.125 in. sample	NA*	NA*
Max operation temp - °C	Continuous Intermittent	65 100 150 190

DETABOND™154		
Characteristics	A-4	B4
Parts of hardener per 100 parts of resin by weight	11.0	4.5
*Working Time - at 77°F	45 min	30 min
† Initial cure time 77°F 150°F 250°F	8 hrs 45 min 20 min	6 hrs 30 min 15 min
‡Post-cure time at a temp in °F	4 hrs @200°F	4 hrs @ 200°F
‡Alternate room temp. aging time at 77°F	4 days	4 days
Working consistency (77°F)	viscous liquid	paste
Working viscosity (77°F) cps	25,000	—

DETABOND™154			
Model Number	Ordering Guide - Resin and Hardener		
	Resin		Hardener
	Part No.	Container	Part Number
DeltaBond™ 154	154-Q	1 quart (2.5 lbs)	A-4 (0.316 lb), B-4 (0.14 lb), (order 1 only)

All hardener part numbers  
A-4, B-4

## THERMAL COMPOUNDS, ADHESIVES AND INTERFACE MATERIALS

### DeltaBond™ 155



**DeltaBond™ 155** is an epoxy adhesive formulated for use within the semiconductor industry. An easy to mix spread thixotropic paste, it offers high heat transfer, low shrinkage, and a coefficient of thermal expansion comparable to that of copper and aluminum. This adhesive is principally used to form thermally conductive joints in fabricated heat sinks and between heat sinks and power devices. When used to bond semiconductors to heat sinks, it also serves as an electrical insulator. Its strong bond to a wide variety of substrates resists severe temperature cycling. **DeltaBond™ 155** is only available in kit size. Simply squeeze out equal lengths and mix to uniform color. Shelf life: 1 year.

DELTABOND™155	
Characteristics	Hardener Type DeltaBond™155
<b>Typical Properties Fully Cured</b>	
Thermal conductivity - W/(m) (°K) (Btu (in.)/(hr) (ft²) (°F))	0.836 5.8
Thermal resistivity - (°C) (in.)watt	47
Bond shear strength 77°F 1 in. overlap - psi 125°F etched aluminum to etched aluminum 212°F	2,600 — —
Heat distortion point - °F	130
Minimum dielectric strength, v/mil, 0.125 in. sample	400
Max operation temp - °C Continuous Intermittent	65 100

DELTABOND™155	
Mixing Proportions and Working Properties	
Parts of hardener per 100 parts of resin	
by volume 100	
*Working Time - at 77°F	90 min
†Initial cure time 77°F 150°F 250°F	8 hrs 45 min 20 min
‡Post-cure time at a temp in °F	4 hrs @ 200°F
‡Alternate room temp. aging time at 77°F	4 days
Working consistency (77°F)	paste
Working viscosity (77°F) cps	paste

DELTABOND™154		
Model Number	Ordering Guide - Resin and Hardener	
	Resin	Hardener
DeltaBond™ 155	155	Kit (3 oz resin, 3 oz hardener) Included in P/N 155

### DeltaBond™ 156



**DeltaBond™ 156** Thermally Conductive Adhesive is a modified acrylic adhesive designed for permanent mounting on components where heat must be effectively transmitted. Recommended for electromechanical assemblies to bond components and dissipate heat, it replaces mechanical fasteners and compressible pads, silicone grease, and epoxies; eliminates air entrapment, and other variables related to epoxy mixing. This soft paste requires no mixing and flows easily to allow thin bond lines. Primer activated, cure begins upon assembly. **DeltaBond™** Activator fixtures at room temperature in less than 5 minutes. Full strength is developed in 4 to 12 hours and fillets become dry to the touch in 24 hours. It is not recommended to use this durable adhesive without the use of **DeltaBond™** Activator. **DeltaBond™ 156** is available in kit size; order 156-K (25 ml Syringe and Activator Kit). Shelf life: 1 year.

DELTABOND™156		
Characteristics	Description	
<b>Typical Properties Fully Cured</b>		
Test	Results	ASTM
Temperature Range	-65 to 300°F (-54 to 149°C) 300°F to (177°C) Intermittent	
Tensile Strength, at break	2360 psi	D638
Modulus	233,000 psi	D638
Elongation, at break	7.75%	D638
Outgassing	2.5% TLM 0.05% CVCM	E595
Coefficient of Thermal Expansion	7.1 x 10e-4 (cm/cm°C)	D1002
Tensile Shear	2500psi	
Thermal Conductivity, K (absolute at 86°F (30°C)	3.47 Btu x in./hr ft² °F (0.50 W/m °C)	

Note: The absolute thermal conductivity test was developed specifically for measuring thermal properties of thin film adhesive bonds.

DELTABOND™156		
Typical Electrical Properties		
Test	Results	ASTM
Dielectric Strength	220 volts/mil	D149
Dielectric Constant, 77°F (25°C)		D150
100 Hz	14.92	
1000 Hz	14.26	
1MM Hz	12.34	
Dissipation Factor, 77°F (25°C)		D150
100 Hz	0.05	
1000 Hz	0.03	
1MM Hz	0.06	
Volume Resistivity	5.2x10e 11 (ohms-cm)	D257
Surface Resistivity	8.6 x 10e 13 (ohms)	D257

Note: **DeltaBond™** Thermally Conductive Adhesive-High Strength contains a metallic filler which, in certain applications, may have an effect on electrical properties. Therefore, test each particular application to ensure that electrical properties are as required.

Model Number	DELTABOND™156		
	Ordering Guide - Resin and Hardener		
	Resin		Hardener
Part No.	Container	Part Number	
DeltaBond™ 156	156-K	Resin Kit Hardener Syringe - 0.85 fl oz - 25 ml - 2 oz net/0.44 oz fl contents bottle -12ml	Included in kit hardener with brush applicator - 4.2 oz total wt/kt

\* Since the hardener/resin reaction is exothermic, it is important that batch size be matched to hardener speed. Working times given are for approximate batch sizes: A—200 gms, B—200 gms. Larger batch sizes will greatly reduce working time.

† After initial cure, material may be handled, removed from fixture, etc., but has not yet achieved full properties and should be room temperature aged or post-cured as shown to achieve full physical and electrical properties.

‡ After initial cure, material may be brought to full physical and electrical properties during post-cure or may be room temperature aged for charted length of time to achieve same full properties.

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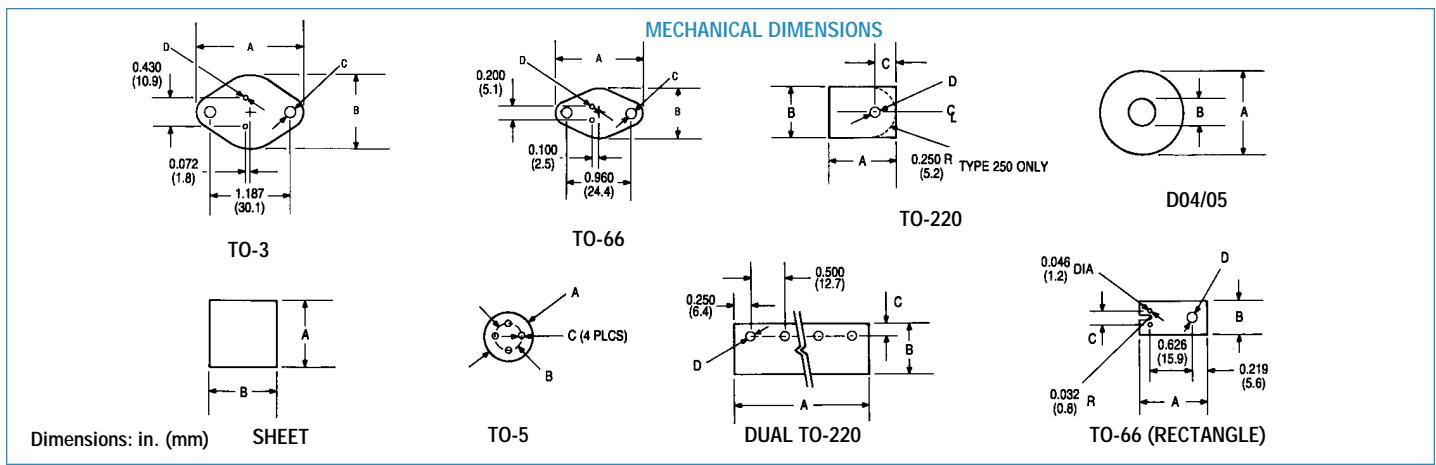
**173/174 SERIES**  
**175 SERIES**
**DeltaPads™ Thermally Conductive Insulators**
**Greaseless Thermally Conductive Kapton® Reinforced Insulators**
**TO-3, TO-66, TO-220, DO-4, DO-5 SHEET**

The 173, 174, and 175 Series are highly efficient thermally conductive insulators designed for semi-conductor interface to heat sinks. Their properties eliminate messy concerns associated with thermal greases.

Characteristics	DeltaPads™ 173-7 Series	DeltaPads™ 173-9 Series	DeltaPads™ 174-9 Series	Kapton® 175-6 Series	Test Method
Material Thickness	0.007 in.	0.009 in.	0.009 in.	0.006 in.	Micrometer
Color	Gray	Gray	Tan	Gray	Visual
Tear Strength, lb/in. Typical	100	100	100	100	ASTM 0624
Volume Resistivity, megohm-cm, Minimum Normal	1.0 x 10e 9	1.0 x 10e 9	1.0 x 10e 13	1 x 10e 13	ASTM D257
Breakdown Voltage, Minimum	4,000	5,000	5,000	6,000	ASTM 0149
Dielectric Constant at 60 Hz and 100 V Maximum	2.70	2.40	2.50	5.5 @ 1,000 Hz	ASTM D 150
Continuous Use Temperature, °C	-60/+200	-60/+200	-60/+200	-60/+200	-
Thermal Conductivity, cal/cm sec. °C, Minimum	3 x 10e -3	3 x 10e -3	1 x 10e -2	1.2 x 10e -3	-
Thermal Resistance (TO-3), 1 in.² °C/W	0.33	0.50	0.25	0.40	-
Recommended Mounting Pressure, lb/in. <sup>2</sup>	350/550	350/550	350/550	350/550	Formula*

\*P (pressure in psi) =  $\frac{T \text{ (torque [in.-lb] x N (number of fasteners)}}{0.2 \times D \text{ (Thread Dia) x A (contact surface area square inches)}}$

173-7 Series		173-9 Series	174-9 Series	175-6 Series	Mechanical Dimensions in. (mm)				
No Adhesive	Adhesive Backing	No Adhesive	No Adhesive	Greaseless	A	B	C	D	Case Style
173-7-210P	-	173-9-210P	174-9-210P	175-6-210P	0.687 (17.4)	0.562 (14.3)	0.218 (5.5)	0.125 (3.2)	TO-220
173-7-220P▲	-	173-9-220P▲	174-9-220P	175-6-220P	0.710 (18.0)	0.500 (12.7)	0.160 (4.1)	0.141 (3.6)	TO-220
173-7-230P	-	173-9-230P	174-9-230P	175-6-230P	0.750 (19.1)	0.500 (12.7)	0.187 (4.8)	0.125 (3.2)	TO-220
173-7-240P	173-7-240A	173-9-240P	174-9-240P	175-6-240P▲	0.750 (19.1)	0.500 (12.7)	0.187 (4.8)	0.147 (3.7)	TO-220
173-7-250P	-	173-9-250P	174-9-250P	175-6-250P	0.865 (22.0)	0.650 (16.5)	0.205 (5.2)	0.140 (3.6)	TO-220
-	-	-	-	175-6-260P	1.000 (25.4)	0.750 (19.1)	0.320 (8.1)	0.141 (3.6)	TO-220
-	-	173-9-280P	-	175-6-280P	0.860 (21.8)	0.740 (18.8)	0.200 (5.1)	0.160 (4.1)	TO-220
173-7-290P	-	173-9-290P	-	-	0.855 (21.7)	0.630 (16.0)	0.230 (5.8)	0.093 (2.4)	TO-220
173-7-310P	-	173-9-310P	174-9-310P	175-6-310P▲	1.593 (40.5)	1.100 (27.9)	0.156 (4.0)	0.062 (1.6)	TO-3
173-7-320P	173-7-320A	173-9-320P	174-9-320P	175-6-320P	1.650 (41.9)	1.140 (29.0)	0.122 (3.1)	0.062 (1.6)	TO-3
173-7-330P	-	173-9-330P	174-9-330P	175-6-330P	1.650 (41.9)	1.140 (29.0)	0.140 (3.6)	0.093 (3.4)	TO-3
173-7-340P	-	173-9-340P	-	175-6-340P	1.780 (45.2)	1.250 (31.8)	0.140 (3.6)	0.093 (3.4)	TO-3
173-7-350P	-	173-9-350P	-	-	1.563 (39.7)	1.050 (26.7)	0.140 (3.6)	0.080 (2.0)	TO-3
173-7-410P	-	173-9-410P	174-9-410P	175-6-410P	0.625 (15.9)OD	0.200 (5.1)ID	N/A	N/A	DO-4, DO-5
173-7-510P	-	173-9-510P	174-9-510P	175-6-510P	0.800 (20.3)OD	0.260 (6.6)ID	N/A	N/A	DO-4, DO-5
173-7-520P	-	173-9-520P	174-9-520P	175-6-520P	1.000 (25.4)OD	0.260 (6.6)ID	N/A	N/A	DO-4, DO-5
173-7-610P	-	173-9-610P	174-9-610P	175-6-610P	1.312 (33.3)	0.762 (19.4)	0.140 (3.6)	0.062(1.6)	TO-66
173-7-710P	-	173-9-710P	-	175-6-710P	0.360 (9.14)OD	0.200 (5.1)ID	0.040 (1.0)	-	TO-5
-	-	173-9-810P	-	175-6-810P	2.000 (50.8)	0.750 (19.1)	0.187 (4.3)	0.125 (3.8)DIA	TO-220
-	-	173-9-820P	-	175-6-820P	4.000 (101.6)	0.750 (19.1)	0.187 (4.3)	0.125 (3.8)DIA	TO-220
-	-	173-9-910P	-	-	1.000 (25.4)	0.500 (12.7)	0.200 (5.1)	0.141 (3.6)	TO-66
173-7-66P	173-7-66A	173-9-66P	174-9-66P	175-6-66P	6.000 (152.4)	6.000 (152.4)	N/A	N/A	SHEET
173-7-1212P	173-7-1212A	173-9-1212P	174-9-1212P	-	12.000 (304.8)	12.000 (304.8)	N/A	N/A	SHEET
-	-	-	-	175-6-1311P	13.000 (330.2)	11.000 (279.4)	N/A	N/A	SHEET



# Mouser Electronics

Authorized Distributor

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